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M16C/1N Group 1. Overview

1.4 Performance Overview

Table 1.2 shows performance overview.

Table 1.2 Performance overview

As of June 2004

Type No.	ROM	RAM	Package	Remarks
M301N2M4T-XXXFP(D)	32Kbytes	1Kbytes		Mask ROM
M301N2M8T-XXXFP(D)			40D6O A	IVIASK ROIVI
M301N2F8TFP(D)	64Kbytes	3Kbytes	48P6Q-A	
M301N2F8FP(D)				Flash memory

(D): Under development

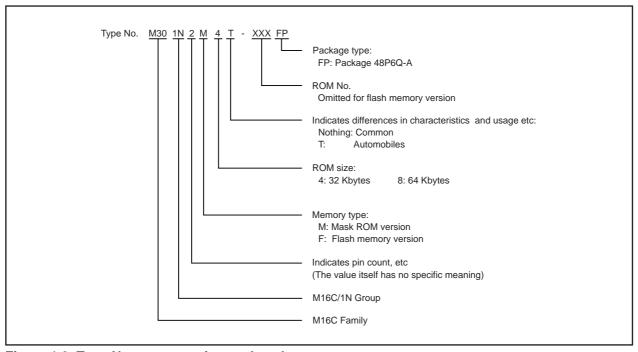


Figure 1.2 Type No., memory size, and package

M16C/1N Group 1. Overview

1.6 Pin Description

Table 1.3 shows the pin description.

Table 1.3 Pin Description

Pin name	Signal name	I/O type	Function
Vcc, Vss	Power supply input	Input	Supply 4.2 to 5.5 V to the Vcc pin. Supply 0 V to the Vss pin.
IVcc	IVcc	Input	Connect a capacitor (0.1 µF) between this pin and Vss.
CNVss	CNVss	Input	Connect it to the Vss pin via resistance (about 5 k Ω).
RESET	Reset input	Input	A "L" on this input resets the microcomputer.
XIN	Clock input	Input	These pins are provided for the main clock oscillation circuit. Connect a ceramic resonator or crystal between the XIN and
Хоит	Clock output	Output	XOUT pins. To use an externally derived clock, input it to the XIN pin and leave the XOUT pin open.
VREF	Reference voltage input	Input	This pin is a reference voltage input for the A/D converter.
P00 to P07	I/O port P0	Input/output	This is an 8-bit CMOS I/O port. It has an input/output port direction register that allows the user to set each pin for input or output individually. When set for input, the user can specify in units of four bits via software whether or not they are tied to a pull-up resistor. These pins are shared with analog input pins. P02 and P03 function as CANO I/O pins by using software.
P10 to P17	I/O port P1	Input/output	This is an 8-bit I/O port equivalent to P0. P10 to P13 are shared with analog inputs and key input interrupts. P14 to P16 are shared with serial I/O pins. P17 is shared with timer input. Can be used as an LED drive port.
P20 to P21	I/O port P2	Input/output	This is a 2-bit I/O port equivalent to P0.
P30 to P37	I/O port P3	Input/output	This is a 8-bit I/O port equivalent to P0. P30 to P33 are shared with timer input/output. P34 to P37 are shared with serial I/O. P34 is shared with analog outputs.
P40 to P47	I/O port P4	Input/output	This is a 8-bit I/O port equivalent to P0. P40 to 41 are shared with analog inputs. P42 to P45 are shared with interrupt inputs. P46 to P47 are shared with the I/O pin of the clock oscillation circuit for the clock.
P50 to P52	I/O port P5	Input/output	This is a 3-bit I/O port equivalent to P0. P50 and P51 function as CAN0 I/O pins by using software.

2.3 Frame Base Register (FB)

FB is configured with 16 bits, and is used for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is configured with 20 bits, indicating the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC is configured with 20 bits, indicating the address of an instruction to be executed.

2.6 User Stack Pointer (USP), Interrupt Stack Pointer (ISP)

Stack pointer (SP) comes in two types: USP and ISP, each configured with 16 bits.

Your desired type of stack pointer (USP or ISP) can be selected by the U flag of FLG.

2.7 Static Base Register (SB)

SB is configured with 16 bits, and is used for SB relative addressing.

2.8 Flag Register (FLG)

FLG consists of 11 bits, indicating the CPU status.

2.8.1 Carry Flag (C Flag)

This flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic/logic unit.

2.8.2 Debug Flag (D Flag)

This flag is used exclusively for debugging purpose. During normal use, it must be set to "0".

2.8.3 Zero Flag (Z Flag)

This flag is set to "1" when an arithmetic operation resulted in 0; otherwise, it is "0".

2.8.4 Sign Flag (S Flag)

This flag is set to "1" when an arithmetic operation resulted in a negative value; otherwise, it is "0".

2.8.5 Register Bank Select Flag (B Flag)

Register bank 0 is selected when this flag is "0"; register bank 1 is selected when this flag is "1".

2.8.6 Overflow Flag (O Flag)

This flag is set to "1" when the operation resulted in an overflow; otherwise, it is "0".

2.8.7 Interrupt Enable Flag (I Flag)

This flag enables a maskable interrupt.

Maskable interrupts are disabled when the I flag is "0", and are enabled when the I flag is "1". The I flag is set to "0" when the interrupt request is accepted.

2.8.8 Stack Pointer Select Flag (U Flag)

ISP is selected when the U flag is "0"; USP is selected when the U flag is "1".

The U flag is set to "0" when a hardware interrupt request is accepted or an INT instruction for software interrupt Nos. 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is configured with three bits, for specification of up to eight processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has priority greater than IPL, the interrupt request is enabled.

2.8.10 Reserved Area

When white to this bit, write "0". When read, its content is indeterminate.



M16C/1N Group 3. Memory

3. Memory

Figure 3.1 is a memory map. The address space extends the 1M bytes from address 0000016 to FFFFF16. From FFFF16 down is ROM. For example, in the M301N2M4T-XXXFP, there is 32K bytes of internal ROM from F800016 to FFFF16. The vector table for fixed interrupts such as the reset are mapped to FFFDC16 to FFFF16. The starting address of the interrupt routine is stored here. The address of the vector table for timer interrupts, etc., can be set as desired using the internal register (INTB). See the section on interrupts for details.

From 0040016 up is RAM. For example, in the M301N2M4T-XXXFP, there is 1K byte of internal RAM from 0040016 to 007FF16. In addition to storing data, the RAM also stores the stack used when calling subroutines and when interrupts are generated.

The SFR area is mapped to 0000016 to 003FF16. This area accommodates the control registers for peripheral devices such as I/O ports, A/D converter, serial I/O, and timers, etc. Any part of the SFR area that is not occupied is reserved and cannot be used for other purposes.

The special page vector table is mapped to FFE0016 to FFFDB16. If the starting addresses of subroutines or the destination addresses of jumps are stored here, subroutine call instructions and jump instructions can be used as 2-byte instructions, reducing the number of program steps.

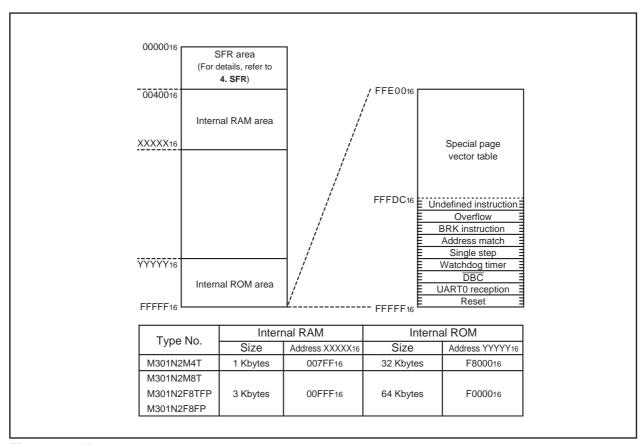


Figure 3.1 Memory map

4. Special Function Registers (SFR)

Address	Register	Symbol	After reset
000016	Ŭ		
000116			
000216			
000316			
000416	Processor mode register 0	PM0	XXXX0X002
000516	Processor mode register 1	PM1	00XXX0X0 ₂
000616	System clock control register 0	CM0	4816
000716	System clock control register 1	CM1	2016
000816	-		
000916	Address match interrupt enable register	AIER	XXXXXX002
000A ₁₆	Protect register	PRCR	XXXXX0002
000B ₁₆			
000C ₁₆	Oscillation stop detection register	CM2	0416
000D ₁₆			
000E ₁₆	Watchdog timer start register	WDTS	XX ₁₆
000F ₁₆	Watchdog timer control register	WDC	000XXXXX ₂
001016			00000002
001116	Address match interrupt register 0	RMAD0	00000002
001216			XXXX00002
001316			
001416			00000002
001516	Address match interrupt register 1	RMAD1	00000002
001616			XXXX00002
001716			
001816			
001916			
001A ₁₆			
001B ₁₆			
001C ₁₆			
001D ₁₆			
001E ₁₆	INT0 input filter select register	INT0F	XXXXX000 ₂
001F ₁₆			
002016			
002116			
002216			
002316			
002416			
002516			
002616			
002716			
002816			
002916			
002A ₁₆			
002B ₁₆			
002C ₁₆			
002D ₁₆			
002E ₁₆			
002F ₁₆			
003016			
003116			
003216			
003316			
003416			
003516			
003616			
003716			
003816			
003916			
003A ₁₆			
003B ₁₆			
003C ₁₆			
003D ₁₆			
003E ₁₆			
003F ₁₆			
	on in the SED area where nothing is allocated are r		

Note 1: Location in the SFR area where nothing is allocated are reserved areas. Do not access these areas for read or write.



Address	Register	Symbol	After reset
004016	. regions.		
004116			
004216			
004316			
004416			
004516	CAN0 wakeup interrupt control register	C01WKIC	XXXXX000 ₂
004616	CAN0 state/error interrupt control register	C01ERRIC	XXXXX000 ₂
004716	0000	0005010	2000000
0048 ₁₆	CANO reception successful interrupt control register	C0RECIC C0TRMIC	XXXXX000 ₂ XXXXX000 ₂
0049 ₁₆	CAN0 transmission successful interrupt control register	COTRIVIC	AAAA0002
004A16			
004C ₁₆			
004D ₁₆	Key input interrupt control register	KUPIC	XXXXX000 ₂
004E ₁₆	A/D conversion interrupt control register	ADIC	XXXXX0002
004F ₁₆	·		
005016			
005116	UART0 transmit interrupt control register	S0TIC	XXXXX0002
005216	UART0 receive interrupt control register	SORIC	XXXXX000 ₂
005316	UART1 transmit interrupt control register	S1TIC	XXXXX000 ₂
005416	UART1 receive interrupt control register	S1RIC	XXXXX000 ₂
005516	Timer 1 interrupt control register	T1IC	XXXXX000 ₂
0056 ₁₆ 0057 ₁₆	Timer X interrupt control register Timer Y interrupt control register	TXIC	XXXXX000 ₂ XXXXX000 ₂
005716	Timer Y interrupt control register Timer Z interrupt control register	TZIC	XXXXX000 ₂ XXXXX000 ₂
005916	CNTR0 interrupt control register	CNTROIC	XXXXX0002 XXXXX0002
005A ₁₆	TCIN interrupt control register	TCINIC	XXXXX0002 XXXXXX0002
005B ₁₆	Timer C interrupt control register	TCIC	XXXXX0002
005C ₁₆	INT3 interrupt control register	INT3IC	XXXXX0002
005D ₁₆	INT0 interrupt control register	INT0IC	XX00X000 ₂
005E ₁₆	INT1 interrupt control register	INT1IC	XX00X0002
005F ₁₆	INT2 interrupt control register	INT2IC	XX00X000 ₂
006016			
006116			
006216			
006316			
0064 ₁₆			
006616			
006716			
006816			
006916			
006A ₁₆			
006B ₁₆			
006C ₁₆			
006D ₁₆			
006E ₁₆			
006F ₁₆			
007016			
007 116			
007216			
007416			
007516			
007616			
007716			
007816			
007916			
007A ₁₆			
007B ₁₆			
007C ₁₆			
007D ₁₆ 007E ₁₆			
007E16			
OU7 F 16			l .

Note 1: Location in the SFR area where nothing is allocated are reserved areas. Do not access these areas for read or write.



Address	Register	Symbol	After reset
010016	1109,000	1 3/11121	
010116			
010216			
010316			
010416			
01B0 ₁₆			
01B1 ₁₆			
01B2 ₁₆			
01B3 ₁₆	Flash memory control register 4 (Note 2)	FMR4	010000002
01B4 ₁₆			
01B5 ₁₆	Flash memory control register 1 (Note 2)	FMR1	0000XX0X2
01B6 ₁₆			
01B7 ₁₆	Flash memory control register 0 (Note 2)	FMR0	XX000001 ₂
01B8 ₁₆			
01B9 ₁₆			
01BA ₁₆			
01BB ₁₆			
01BC ₁₆			
01BD ₁₆			
01BE ₁₆			
01BF₁6			
0215 ₁₆ 0216 ₁₆			
0217 ₁₆ 0218 ₁₆			
021816			
0219 ₁₆			
021A ₁₆			
021B ₁₆			
021C ₁₆			
021D ₁₆			
021E ₁₆			
021116	CAN0 message control register 0	COMCTLO	00.5
022016	CANO message control register 0 CANO message control register 1	C0MCTL0 C0MCTL1	0016 0016
022116	CANO message control register 2	COMCTL1	0016
022316	CANO message control register 3	COMCTL2	0016
022316	CANO message control register 4	COMCTL3	0016
022516	CANO message control register 5	COMCTL5	0016
022616	CANO message control register 6	COMCTL6	0016
022716	CAN0 message control register 7	COMCTL7	0016
022816	CANO message control register 8	COMCTL8	0016
022916	CAN0 message control register 9	COMCTL9	0016
022A ₁₆	CAN0 message control register 10	C0MCTL10	0016
022B ₁₆	CANO message control register 11	C0MCTL11	0016
022C ₁₆	CAN0 message control register 12	C0MCTL12	0016
022D ₁₆	CANO message control register 13	C0MCTL13	0016
022E ₁₆	CANO message control register 14	C0MCTL14	0016
022F ₁₆	CAN0 message control register 15	C0MCTL15	0016
023016			X000001 ₂
023116	CAN0 control register	C0CTLR	XX0X0000 ₂
023216	CANO LL	1000-0	0016
023316	CAN0 status register	COSTR	X000001 ₂
023416	OANIO allat atatua	000070	000016
023516	CAN0 slot status register	COSSTR	000016
023616	0.110.11	00100	000016
023716	CAN0 interrupt control register	COICR	000016
023816	CANO sector de d.ID se sist	00100	000016
023916	CAN0 extended ID register	COIDR	000016
023A ₁₆	OANIO C. C.	0000::-	XX ₁₆
023B ₁₆	CAN0 configuration register	COCONR	XX ₁₆
023C ₁₆	CAN0 receive error count register	CORECR	0016
023D ₁₆	CAN0 transmit error count register	COTECR	0016
023E ₁₆			·
023F ₁₆			
-	•	<u> </u>	

Note 1: Location in the SFR area where nothing is allocated are reserved areas. Do not access these areas for read or write. Note 2: These registers are available on flash memory versions only.

Address	Register	Symbol	After reset
024016	. 5		
024116			
024216			
024316			
024416	CAN0 acceptance filter support register	C0AFS	XX ₁₆
024516	Critto doceptarios inter support register	00/110	XX ₁₆
024616			
024716			
024816			
024916			
024A ₁₆			
024B ₁₆ 024C ₁₆		_	
024C ₁₆ 024D ₁₆			
024D16 024E16			
024F ₁₆			
025016			
025116			
025216			
025316			
025416			
025516			
025616			
025716			
025816			
025916			
025A ₁₆			
025B ₁₆			
025C ₁₆			
025D ₁₆			
025E ₁₆		0011/5	V222V0V0V
025F ₁₆	CAN0 clock select register	CCLKR	X000XXXX ₂
0260 ₁₆ 0261 ₁₆			XX ₁₆ XX ₁₆
026216			XX16 XX16
026316	CAN0 slot 0: Identifier / DLC		XX16
026416			XX16
026516			XX16
026616			XX16
026716			XX ₁₆
026816			XX ₁₆
026916	CANO alat O Data Field		XX ₁₆
026A ₁₆	CAN0 slot 0: Data Field		XX ₁₆
026B ₁₆			XX ₁₆
026C ₁₆			XX ₁₆
026D ₁₆			XX ₁₆
026E ₁₆	CAN0 slot 0: Time Stamp		XX ₁₆
026F ₁₆	o. a. to slot o. Timo otamp		XX ₁₆
027016			XX16
027116			XX16
027216	CAN0 slot 1: Identifier / DLC		XX16
027316			XX16
0274 ₁₆ 0275 ₁₆			XX16
027516			XX ₁₆ XX ₁₆
027616			XX16 XX16
027716			XX16
027816			XX16
027A ₁₆	CAN0 slot 1: Data Field		XX16
027B ₁₆			XX16
027C ₁₆			XX ₁₆
027D ₁₆			XX ₁₆
027E ₁₆	CANO plot 1. Time Stomp		XX ₁₆
027F ₁₆	CAN0 slot 1: Time Stamp		XX ₁₆



C289 tr	Address	Register	Symbol	After reset
C281 ts C282		regiotei	Cymbol	
CARD Sich 2 Identifier / DLC				
OZB36s OZB4s OZB6s OZB				
D.284 str. D.285 str. D.2		CAN0 slot 2: Identifier / DLC		
0.285/s 0.286/s				
0.288 0.287 0.288 0.286 0.28				
C287 C288				
C288 C289 C280				
O2894 O28A-11 O28C-12 O28C-1	028716			XX ₁₆
O2894 O28A-11 O28C-12 O28C-1	028816			XX ₁₆
CARD	028916			XX ₁₆
C28B-Is C28C-Is C28C		CANO slot 2: Data Field		
Description				
CANO slot 2: Time Stamp				
C28E-is C28Fis C28Fis C299is				
CANO slot 2: Time Stamp				
C290		CAN0 slot 2: Time Stamp		
C291-ta C292-ta C292-ta C293-ta C293		'		
C292-16 C293-16 C293				
CANO slot 3: Identifier / DLC XX16 XX1				
C29416		CAND dot 3: Identifier / DLC		
D29516 D29616 D		OANO SIOLO. IUGITIIIGI / DEO		
D29516 D29616 D	029416			XX ₁₆
D29916 D				
CANO slot 3: Data Field				
CANO slot 3: Data Field XX+6 XX				
CANO slot 3: Data Field				
O29A16				
C29B16 C29C18 C		CAN0 slot 3: Data Field		
C29C16				
D29D16 D29E18 D29E18 D29E18 D2AD16 D				
CANO slot 3: Time Stamp XX16 XX				
CANO slot 3: Time Stamp XX+6 XX				
OZA716 OZA216 OZA216 OZA216 OZA216 OZA216 OZA316 OZA316 OZA316 OZA316 OZA316 OZA416 OZA516 O		CANIC clot 2: Time Stome		XX ₁₆
O2A1-6	029F ₁₆	CANO SIOL 3. Time Stamp		XX ₁₆
O2A1-6	02A0 ₁₆			XX ₁₆
O2A216 O2A316 O2A416 O2A516 O				
CANO slot 4: Identifier / DLC				
O2A416 O2A516 O2A616 O		CAN0 slot 4: Identifier / DLC		
02A516 02A616 02A716 02A716 02A916 02A916 02AA16 02AB16 02AB16 02AB16 02AB16 02AC16 02AD16 02AC16 02AD16 02AE16 02AE16 02AE16 02B16 02B16 02B16 02B16 02B316 02B316 02B316				
O2A616 O2A716 O2A816 O2A916 O2AA16 O				
O2A716 O2A816 O2A916 O2A916 O2AA16 O				
O2A816 O2A916 O2AA16 O2AA16 O2AB16 O2B16 O2B16				
O2A916 O2AA16 O2AB16 O2AC16 O				
O2AA16 O2AB16 O2AB16 O2AD16 O2AD16 O2AE16 O2AE16 O2AE16 O2AE16 O2AE16 O2AE16 O2BE16 O				
OZAR16 OZAB16 OZAC16 OZAC16 OZAC16 OZAF16 OZAF16 OZAF16 OZAF16 OZAF16 OZAF16 OZBC16 O	02A9 ₁₆	CANO slot 4: Data Field		XX ₁₆
O2AC16 O2AD16 O2AD16 O2AD16 O2AD16 O2AD16 O2AD16 O2AD16 O2AD16 O2AD16 O2BD16 O		CANO SIOI 4. Data Fleiu		XX ₁₆
O2AC16 O2AD16 O2AD16 O2AD16 O2AD16 O2AD16 O2AD16 O2AD16 O2AD16 O2BD16 O	02AB ₁₆			
02AD16 02AE16 02AE16 02AE16 02AE16 02AE16 02AE16 02BE16 02BU16 02BU16<	02AC ₁₆			
O2AE16 O2AF16 O2B016 O				
02AF16 CAN0 slot 4: Time Stamp 02B016 02B16 02B216 02B216 02B316 02B316 02B416 02B516 02B516 02B516 02B716 02B716 02B316 02B316				
02B016 02B116 02B216 02B216 02B316 02B416 02B416 02B516 02B516 02B616 02B716 02B816 02B316 02B316		CAN0 slot 4: Time Stamp		
02B116 02B216 02B316 02B316 02B416 02B416 02B516 02B616 02B716 02B716 02B816 02B916 02B316 02B316				
02B216 02B316 02B416 02B416 02B516 02B616 02B716 02B716 02B816 02B816 02B316 02B316				
O2B316				
02B316 02B416 02B516 02B516 02B616 02B716 02B816 02B816 02B816 02B816 02B816 02B816 02B216 02B816 02B216 02B816 02B216 02B816 02B216 02B816 02B216 02B816 02B216 02B816 02B816 02B816		CAN0 slot 5: Identifier / DLC		
02B516 XX16 02B616 XX16 02B716 XX16 02B816 XX16 02B916 XX16 02B16 XX16 02B26 XX16 02B26 XX16 02B26 XX16 02B27 XX16 02B26 XX16 02B27 XX16 02B27 XX16 02B27 XX16				
02B616 02B716 02B816 02B916 02BA16 02BA16 02BB16 02BB16 02BC16 02BC16 02BD16 02BC16 02BE16 02BC16 02BC16 02BC16				
02B716 02B816 02B916 02BA16 02BB16 02BC16 02BD16 02BD16 02BE16 02BE16 02BE16 02BE16 02BE16 02BE16 02BE16 02BE16 02BE16				
02B716 02B816 02B916 02BA16 02BB16 02BB16 02BC16 02BD16 02BE16 02BC16 02BE16 02BC16 02BC16 02BC16 02BC16 02BC16 02BC16 02BC16 02BC16 02BC16 02BC16 02BC16				
02B816 02B916 02BA16 02BB16 02BB16 02BC16 02BD16 02BC16 02BE16 02BC16 02BE16 02BC16	02B7 ₁₆			
02B916 02BA16 02BB16 02BC16 02BD16 02BD16 02BE16 XX16 02BE16 XX16 02BE16 XX16 02BC16 XX16				
02BA16 02BB16 02BC16 02BD16 02BD16 02BE16 02BE16 XX16 02BE16 XX16				
02BB16 XX16 02BC16 XX16 02BD16 XX16 02BE16 XX16 02BE16 XX16		CAN0 slot 5: Data Field		
02BC16 XX16 02BD16 XX16 02BE16 XX16 02BE16 XX16				
02BD16 XX16 02BE16 CANO clot 5: Time Stamp				
02BE ₁₆ CANO clot 5: Time Stome				
02BF ₁₆		CAN0 slot 5: Time Stamp		
	02BF ₁₆	S. 1. 10 S.O. O. Tillio Glarip		XX ₁₆



Address	Register	Symbol	After reset
02C0 ₁₆	1.129,000	27	XX ₁₆
02C1 ₁₆			XX16
02C2 ₁₆	CANIC plat College (For / DLC		XX ₁₆
02C3 ₁₆	CAN0 slot 6: Identifier / DLC		XX ₁₆
02C4 ₁₆			XX ₁₆
02C5 ₁₆			XX ₁₆
02C6 ₁₆			XX ₁₆
02C7 ₁₆			XX ₁₆
02C8 ₁₆			XX ₁₆
02C9 ₁₆	CAN0 slot 6: Data Field		XX ₁₆
02CA ₁₆	Critto siot o. Bata i iola		XX ₁₆
02CB ₁₆			XX16
02CC ₁₆			XX ₁₆
02CD ₁₆			XX ₁₆
02CE ₁₆	CAN0 slot 6: Time Stamp		XX16
02CF ₁₆	'		XX16
02D0 ₁₆ 02D1 ₁₆			XX16
			XX16 XX16
02D2 ₁₆ 02D3 ₁₆	CAN0 slot 7: Identifier / DLC		
02D3 ₁₆ 02D4 ₁₆			XX16 XX16
02D416 02D516			XX16 XX16
02D516 02D616		1	XX16 XX16
02D016 02D716			XX16 XX16
02D716 02D816			XX16 XX16
02D9 ₁₆	0.000		XX16
02DA ₁₆	CAN0 slot 7: Data Field		XX ₁₆
02DB ₁₆			XX ₁₆
02DC ₁₆			XX ₁₆
02DD ₁₆			XX16
02DE ₁₆	CANIO alat 7: Tima Stamp		XX ₁₆
02DF ₁₆	CAN0 slot 7: Time Stamp		XX ₁₆
02E0 ₁₆			XX ₁₆
02E1 ₁₆			XX ₁₆
02E2 ₁₆	CAN0 slot 8: Identifier / DLC		XX ₁₆
02E3 ₁₆	CANA SIGN S. INCINITION A DEC		XX ₁₆
02E4 ₁₆			XX ₁₆
02E5 ₁₆			XX ₁₆
02E6 ₁₆			XX16
02E7 ₁₆ 02E8 ₁₆			XX16
02E9 ₁₆			XX16 XX16
02E916 02EA16	CAN0 slot 8: Data Field		
02EA16			XX16 XX16
02EC ₁₆			XX16 XX16
02ED ₁₆			XX16 XX16
02EE ₁₆			XX16 XX16
02EF ₁₆	CAN0 slot 8: Time Stamp		XX16
02F0 ₁₆		1	XX16
02F1 ₁₆			XX ₁₆
02F2 ₁₆	CANO plat Or Identifier / DLC		XX16
02F3 ₁₆	CAN0 slot 9: Identifier / DLC		XX16
02F4 ₁₆			XX ₁₆
02F5 ₁₆			XX ₁₆
02F6 ₁₆			XX ₁₆
02F7 ₁₆			XX ₁₆
02F8 ₁₆			XX ₁₆
02F9 ₁₆	CAN0 slot 9: Data Field		XX ₁₆
02FA ₁₆	2		XX ₁₆
02FB ₁₆			XX ₁₆
02FC ₁₆			XX16
02FD ₁₆			XX16
02FE ₁₆	CAN0 slot 9: Time Stamp		XX16
02FF ₁₆	·	<u> </u>	XX ₁₆



Address	Register	Symbol	After reset
030016	rogiotor	Cymbol	XX16
030116			XX ₁₆
030216	0.000 1 (40 11) (7) (81 0		XX ₁₆
030316	CAN0 slot 10: Identifier / DLC		XX ₁₆
030416			XX ₁₆
030516			XX ₁₆
030616			XX16
030716			XX16
030816			XX16
030916			XX16
030A ₁₆	CAN0 slot 10: Data Field		XX16
030B ₁₆			XX16
030C ₁₆			XX16
030D ₁₆			XX16
030E ₁₆			XX16
030F ₁₆	CAN0 slot 10: Time Stamp		XX16 XX16
031016			XX16 XX16
031016			XX16 XX16
031716			XX16 XX16
031216	CAN0 slot 11: Identifier / DLC		XX16 XX16
031416			XX16
031516			XX16
031616			XX16
031716			XX ₁₆
031816			XX16
031916	CAN0 slot 11: Data Field		XX16
031A ₁₆			XX16
031B ₁₆			XX16
031C ₁₆			XX16
031D ₁₆			XX ₁₆
031E ₁₆	CAN0 slot 11: Time Stamp		XX16
031F ₁₆			XX ₁₆
032016			XX16
032116			XX ₁₆
032216	CAN0 slot 12: Identifier / DLC		XX ₁₆
032316			XX ₁₆
032416			XX ₁₆
032516			XX ₁₆
032616			XX ₁₆
032716			XX ₁₆
032816			XX ₁₆
032916	CAN0 slot 12: Data Field		XX ₁₆
032A ₁₆	Orato dot 12. Bata i loid		XX ₁₆
032B ₁₆			XX ₁₆
032C ₁₆			XX ₁₆
032D ₁₆			XX ₁₆
032E ₁₆	CAN0 slot 12: Time Stamp		XX ₁₆
032F ₁₆	S. 1.15 Glot 12. Timo Glorip		XX ₁₆
033016			XX ₁₆
033116			XX ₁₆
033216	CAN0 slot 13: Identifier / DLC		XX ₁₆
033316	Onivo side to, luctimier / DEO		XX ₁₆
033416			XX ₁₆
033516		<u> </u>	XX ₁₆
033616			XX ₁₆
033716			XX ₁₆
033816			XX ₁₆
033916	CANO clot 12: Data Field		XX ₁₆
033A ₁₆	CAN0 slot 13: Data Field		XX ₁₆
033B ₁₆			XX16
033C ₁₆			XX16
033D ₁₆			XX ₁₆
033E ₁₆	CANIC SISTAGE TIME OF STATE		XX ₁₆
033F ₁₆	CAN0 slot 13: Time Stamp		XX16
			1.000



5. Electrical Characteristics

Table 5.1 Absolute maximum ratings

Symbol		Parameter	Condition	Rated value	Unit
Vcc	Supply voltage			- 0.3 to 6.5	V
Vı	Input voltage	RESET, VREF, XIN P00 to P07, P10 to P17, P20, P21, P30 to P37, P40 to P47, P50 to P52, CNVss (Note 1)		- 0.3 to Vcc + 0.3	V
Vo	Output voltage	P00 to P07, P10 to P17, P20, P21, P30 to P37, P40 to P47, P50 to P52, XOUT		- 0.3 to Vcc + 0.3	V
		IVcc		- 0.3 to 2.8V	V
Pd	Power dissipation	n	Topr = 25 °C	300	mW
Topr	Operating ambient temperature			- 40 to 85 (Note 2)	°C
Tstg	Storage tempera	ature		- 65 to 150	°C

Note 1: CNVss pin of flash memory version: -0.3 to 6.5 V

Note 2: When flash memory version is program/erase mode: 0 to 60 °C



Table 5.2 Recommended operating conditions
(Unless otherwise noted: Vcc = 4.2V to 5.5V, Topr = -40 to 85°C)

Company of		Darameter			Standard		
Symbol		Parameter			Тур.	Max.	Unit
Vcc	Supply voltage			4.2	5.0	5.5	V
Vss	Supply voltage				0		V
VIH	HIGH input voltage	P00 to P07, P10 to P17, P20, P21, P30 P50 to P52, XIN, RESET, CNVss	to P37, P40 to P47,	0.8Vcc		Vcc	٧
VIL	LOW input voltage	P0o to P07, P1o to P17, P2o, P21, P3o to P37, P4o to P47, P5o to P52, Xin, RESET, CNVss		0		0.2Vcc	V
IOH (peak)	HIGH peak output current	P00 to P07, P10 to P17, P20, P21, P30 to P37, P40 to P47, P50 to P52				- 10.0	mA
IOH (avg)	HIGH average output current	P00 to P07, P10 to P17, P20, P21, P30 to P37, P40 to P47, P50 to P52				- 5.0	mA
IOL (peak)	LOW peak	P00 to P07, P20, P21, P30 to P37, P40	to P47, P50 to P52			10.0	mA
	output current	P10 to P17	HIGH POWER			20.0	mA
			LOW POWER			10.0	IIIA
IOL (avg)	LOW average	P00 to P07, P20, P21, P30 to P37, P40 to P47, P50 to P52				5.0	mA
	output current	P10 to P17	HIGH POWER			10.0	mA
			LOW POWER			5.0	IIIA
f (XIN)	Main clock input oscillation frequency (Note 3) Vcc=4.2V to 5.5V		0		16	MHz	
f (Xcin)	Subclock oscillat	ion frequency			32.768	50	kHz

Note 1: The average output current is an average value measured over 100ms.

Note 2: Keep output current as follows:

The sum of port P00 to P03, P13 to P17, P21, P34 to P37, P46, P47, P50 to P52 IoL (peak) is under 60 mA. The sum of port P00 to P03, P13 to P17, P21, P34 to P37, P46, P47, P50 to P52 IoH (peak) is under 60 mA. The sum of port P04 to P07, P10 to P12, P20, P30 to P33, P40 to P45 IoL (peak) is under 60 mA. The sum of port P04 to P07, P10 to P12, P20, P30 to P33, P40 to P45 IoH (peak) is under 60 mA.

Note 3: Relationship between main clock oscillation frequency and supply voltage is shown as below.

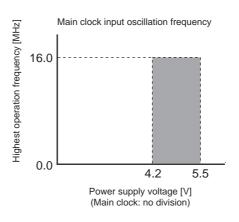


Table 5.3 Electrical characteristics (1) (Unless otherwise noted: Vcc = 5V, Vss = 0V at Topr = -40 to 85°C, f(XIN) = 16MHz)

Symbol		Doromotor		Magguring condition	5	Standard		
Symbol		Parameter		Measuring condition	Min.	Тур.	Max.	Unit
Vон	HIGH output	GH output P0o to P07,P1o to P17,P20	o P17,P20 to P21,	Іон = - 5 mA	3.0			.,
	voltage	P30 to P37,P40 t	o P47,P50 to P52	Ιοн = - 200 μA	4.7			V
Vон	HIGH output	Хоит	HIGH POWER	Іон = - 1 mA	3.0			V
	voltage		LOW POWER	Iон = - 0.5 mA	3.0			V
Vон	HIGH output	Хсоит	HIGH POWER	No load		2.5		V
	voltage		LOW POWER	No load		1.6		V
Vol	/OL LOW output	P00 to P07,P20,F	P21,P30 to P37,	IoL = 5 mA			2.0	V
	voltage	tage D40 to D47 D50 to D50	IoL = 200 μA			0.45	V	
VoL	OL LOW output	P10 to P17	HIGH POWER	IoL = 10 mA			2.0	V
	voltage		LOW POWER	IoL = 5 mA			2.0	V
Vol	LOW output	Хоит	HIGH POWER	IOH = 1 mA			2.0	.,
	voltage		LOW POWER	Іон = 0.5 mA			2.0	· V
Vol	LOW output	Хсоит	HIGH POWER	No load		0		
voltage	voltage		LOW POWER	No load		0		V
VT+ -VT-	Hysteresis	CNTR ₀ ,TCIN, INT ₀ to INT ₃ ,CLI RxD ₀ ,RxD ₁ ,Kl ₀ t			0.2		0.8	V
VT+ -VT-	Hysteresis	eresis RESET			0.2		1.8	V
Іін	HIGH input current	P00 to P07,P10 t P30 to P37,P40 t XIN,RESET,CNV	o P47,P50 to P52,	VI = 5V			5.0	μA
lıL	LOW input current	P00 to P07,P10 t P30 to P37,P40 t XIN,RESET,CNV	o P47,P50 to P52,	VI = 0V			-5.0	μA
RPULLUP	Pull-up resistor	P00 to P07,P10 t P30 to P37,P40 t	o P17,P20,P21, o P47,P50 to P52	Vi = 0V	30.0	50.0	167.0	kΩ
Rfxin	Feedback resistor	XIN				1.0		МΩ
Rfxcin	Feedback XCIN resistor					15.0		ΜΩ
VRAM	RAM retention	n voltage		When clock is stopped	2.0			V
Rosc	Oscillation fre	equency of	Mask ROM		000	000	4000	
	On-chip oscill	ator	Flash memory		300	600	1200	0 kHz

Table 5.7 A/D conversion characteristics
(Unless otherwise noted: VCC = VREF = 5V, Vss = 0V at Topr = 25°C, f(XIN) = 16MHz)

Symbol	Parameter		Measuring condition		S	Standard		
Cyrribor					Min.	Тур.	Max.	Unit
_	Resolution		VREF=VCC				10	Bits
_	Absolute	Sample & hold function not available	VREF =VCC = 5V	1			±3	LSB
	accuracy	Sample & hold function available(10bit)	VREF =VCC = 5V	ANo to AN11 input			±3	LSB
				ANEX ₀ , ANEX ₁ input, external op-amp connected mode			±7	LSB
		Sample & hold function available(8bit)	VREF =VCC = 5V	•			±2	LSB
RLADDER	Ladder resistance		VREF =VCC		10		40	kΩ
tconv	Conversion time(10bit)		f(XIN)=10MHz, Ø	ØAD=fAD=10MHz	3.3			μs
tconv	Conversion time(8bit)		f(XIN)=10MHz, Ø	ØAD=fAD=10MHz	2.8			μs
t SAMP	Sampling time		f(XIN)=10MHz, Ø	ØAD=fAD=10MHz	0.3			μs
VREF	Reference voltage		f(XIN)=10MHz, Ø	ØAD=fAD=10MHz	2		Vcc	V
VIA	Analog inp	out voltage	f(XIN)=10MHz, Ø	ØAD=fAD=10MHz	0		VREF	V

Note 1: Divide the fAD if f(XIN) exceeds 10MHz, and make AD operation clock frequency (ØAD) equal to or lower than 10MHz.

Table 5.8 D/A conversion characteristics
(Unless otherwise noted: VCC = VREF = 5V, Vss = 0V at Topr = 25°C, f(XIN) = 16MHz)

Cumple of	Doromotor	Manageria a condition	5	I limit		
Symbol	Parameter	Measuring condition	Min.	Тур.	Max.	Unit
_	Resolution				8	Bits
_	Absolute accuracy				1.0	%
t su	Setup time				3	μs
Ro	Output resistance		4	10	20	kΩ
Ivref	Reference power supply input current	(Note 1)			1.5	mA

Note 1: The A/D converter's ladder resistance is not included.

When D/A register contents are not "0016", the current IVREF always flows even though VREF may have been set to be unconnected by the A/D control register.

5.1 Timing requirements

(Unless otherwise noted: Vcc = 5V, Vss = 0V at Topr = -40 to 85°C)

Table 5.9 XIN input

Cumbal	Dovomotor	Stand	ndard	Unit
Symbol	Parameter	Min.	Max.	Offic
tc(XIN)	XIN input cycle time	62.5		ns
twH(XIN)	XIN input HIGH pulse width			ns
twL(XIN)	Xın input LOW pulse width	30		ns

Table 5.10 CNTRo input

Cumbal	Dovomotor	Standard		Unit
Symbol	Parameter	Min.	Max.	Ullit
tc(CNTR0)	CNTRo input cycle time	100		ns
twH(CNTR0)	CNTRo input HIGH pulse width 40		ns	
twL(CNTR0)	CNTR ₀ input LOW pulse width	40		ns

Table 5.11 TCIN input

Symbol	Doromotor	Star	ndard	Unit
Symbol	Parameter	Min.	Max.	Offic
tc(TCIN)	TCIN input cycle time	400(Note 1)		ns
twH(TCIN)	TCIN input HIGH pulse width	200(Note 2)		ns
twL(TCIN)	TCIN input LOW pulse width	200(Note 2)		ns

Note 1: Use the greater value, either (1/digital filter clock frequency X 6) or min. value.

Note 2: Use the greater value, either (1/digital filter clock frequency X 3) or min. value.

Table 5.12 Serial I/O

Cumbal	Doromotor	Standard		Unit
Symbol	Parameter		Max.	Offic
tc(CK)	CLKi input cycle time	200		ns
tw(CKH)	CLKi input HIGH pulse width	100		ns
tw(CKL)	CLKi input LOW pulse width	100		ns
td(C-Q)	TxDi output delay time		80	ns
th(C-Q)	TxDi hold time	0		ns
tsu(D-C)	RxDi input setup time	30		ns
th(C-D)	RxDi input hold time	90		ns

Table 5.13 External interrupt INTi input

Symbol	Darameter	Star	dard	Unit
Symbol	Parameter		Max.	Offic
tw(INH)	INTi input HIGH pulse width	250(Note 1)		ns
tw(INL)	INTi input LOW pulse width	250(Note 2)		ns

Note 1: When the $\overline{\text{INTo}}$ input filter select bit selects the digital filter, use the $\overline{\text{INTo}}$ input HIGH pulse width to the greater value, either (1/digital filter clock frequency X 3) or min. value.

Note 2: When the INTo input filter select bit selects the digital filter, use the INTo input LOW pulse width to the greater value, either (1/digital filter clock frequency X 3) or min. value.



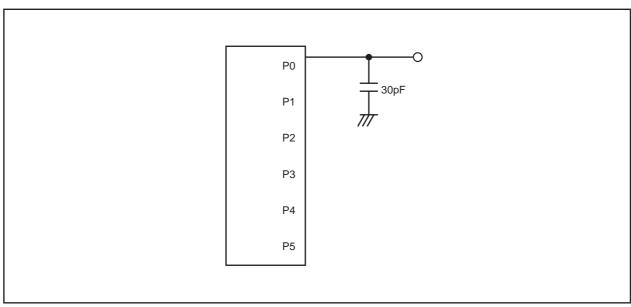


Figure 5.1 Port P0 to P5 measurement circuit

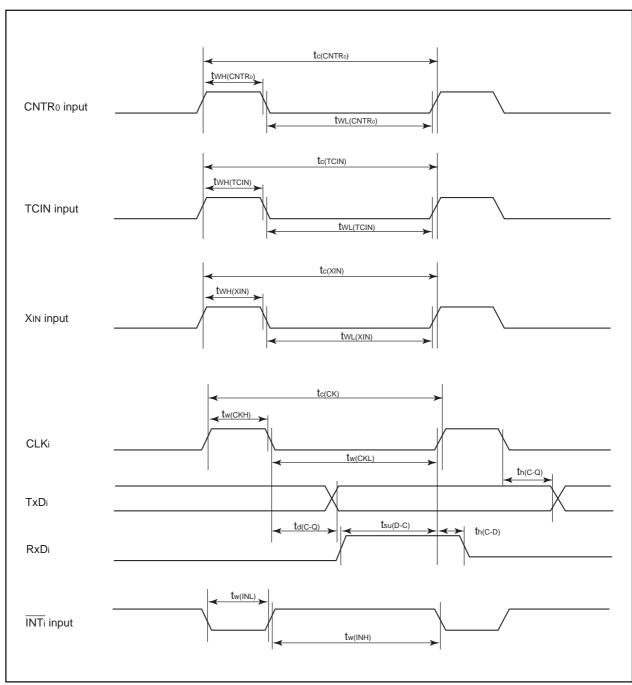


Figure 5.2 Vcc=5V timing diagram

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